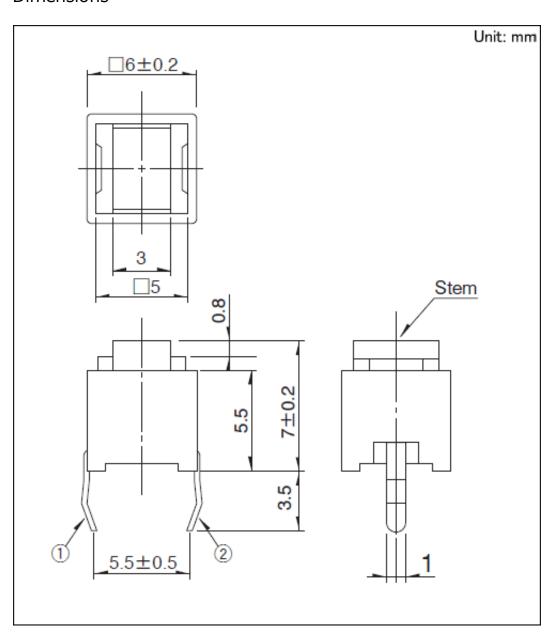


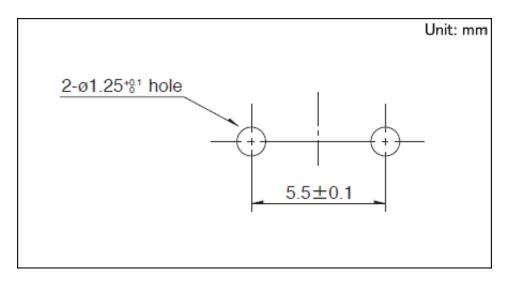
6.0mm Square Type (Snap-in) SKEG Series

| Top push type | | |
|-------------------------------|-----------------------|--|
| Туре | | Snap-in |
| Operating force | | 1.96N |
| Operating direction | | Top push |
| Travel | | 1mm |
| Operating life (1mA 5V DC) | | 100,000 cycles |
| Initial contact resistance | | 1 k Ω max. |
| Stem color | | Dark gray |
| Stem | | Flat stem |
| Series type | | Soft feeling type |
| Operating temperature range | | -20℃ to +70℃ |
| Rating (max.) | | 5mA 12V DC |
| Rating (min.) | | 10μΑ 1V DC |
| Electrical performance | Insulation resistance | 100M Ω min. 100V DC for 1min. |
| | Voltage proof | 250V AC for 1 min. |
| Durability | Vibration | 10 to 55 to 10Hz/min., the amplitude is 1.5mm for all the frequencies, in the 3 direction of X, Y and Z for 2 hours respectively |
| Environmental performance | Cold | -30±2℃ for 96h |
| | Dry heat | 80±2℃ for 96h |
| | Damp heat | 60±2℃, 90 to 95%RH for 96h |
| Minimum order unit (pcs.) | Japan | 1,000 |
| | Export | 1,000 |

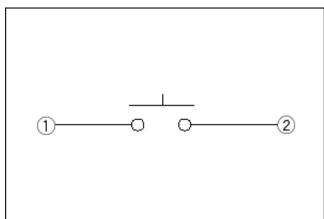
Dimensions



Mounting Hole Dimensions



Circuit Diagram



Packing Specifications

Bulk

| Number of packages (pcs.) | s 1 case / Japan | 10,000 |
|----------------------------------|-------------------------|-------------|
| | 1 case / export packing | 30,000 |
| Export package measurements (mm) | | 309×476×347 |

Soldering Conditions

Conditions for Auto-dip

| Items | Condition |
|------------------------|---|
| Flux built-up | Mounting surface should not be exposed to flux |
| Preheating temperature | Ambient temperature of the soldered surface of PC board. 100℃ max. |
| Preheating time | 45s max. |
| Soldering temperature | 255℃ max. |
| Duration of immersion | 5s max. |
| Number of soldering | 2 times max. |

Manual Soldering

| Items | Condition |
|----------------------------|-----------|
| Soldering temperature | 350℃ max. |
| Duration of soldering | 3s max. |
| Capacity of soldering iron | 20W max. |

- 1. Consult with us for availability of TACT switch™ washing.
- 2. Prevent flux penetration from the top side of the TACT switch™.
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch returns to normal temperature.
- 5. Use the flux with a specific gravity of at least 0.81.

(EC-19s-8 by TAMURA Corporation, or their equivalents.)

Notes are common to this series/models.

- 1. This site catalog shows only outline specifications. When using the products, please obtain formal specifications for supply.
- 2. Please use 1.6mm thick PC boards. (For horizontal type, 1.0mm)
- 3. Please place purchase orders per minimum order unit (integer).
- 4. This products can be used in vehicles.
 - Although these products are designed to perform over a wide operating temperature range, please ensure that you receive and read the formal delivery specifications before use.